

MCR8SDG, MCR8SMG, MCR8SNG



Expertise Applied | Answers Delivered

Sensitive Gate Silicon Controlled Rectifiers Reverse Blocking Thyristors

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Designed primarily for half-wave ac control applications, such as motor controls, heating controls, and power supplies; or wherever half-wave, silicon gate-controlled devices are needed.

Features

- Sensitive Gate Allows Triggering by Microcontrollers and other Logic Circuits
- Blocking Voltage to 800 V
- On-State Current Rating of 8 A RMS at 80°C
- High Surge Current Capability – 80 A
- Rugged, Economical TO-220AB Package
- Glass Passivated Junctions for Reliability and Uniformity
- Minimum and Maximum Values of IGT, VGT and IH Specified for Ease of Design
- Immunity to dv/dt – 5 V/ μ sec Minimum at 110°C
- These are Pb-Free Devices

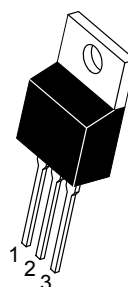
MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

| Rating | Symbol | Value | Unit |
|---|--|-------------------|------------------------|
| Peak Repetitive Off-State Voltage (Note 1) ($T_J = -40$ to 110°C , Sine Wave, 50 to 60 Hz) | V_{DRM} , V_{RRM} | 400 600 800 | V |
| On-State RMS Current (180° Conduction Angles; $T_C = 80^\circ\text{C}$) | $I_{\text{T(RMS)}}$ | 8.0 | A |
| Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave, 60 Hz, $T_J = 110^\circ\text{C}$) | I_{TSM} | 80 | A |
| Circuit Fusing Consideration ($t = 8.33$ ms) | I^2t | 26.5 | A^2sec |
| Forward Peak Gate Power (Pulse Width ≤ 10 μs , $T_C = 80^\circ\text{C}$) | P_{GM} | 5.0 | W |
| Forward Average Gate Power ($t = 8.3$ ms, $T_C = 80^\circ\text{C}$) | $P_{\text{G(AV)}}$ | 0.5 | W |
| Forward Peak Gate Current (Pulse Width ≤ 10 μs , $T_C = 80^\circ\text{C}$) | I_{GM} | 2.0 | A |
| Operating Junction Temperature Range | T_J | -40 to 110 | $^\circ\text{C}$ |
| Storage Temperature Range | T_{stg} | -40 to 150 | $^\circ\text{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

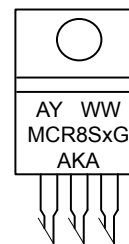
1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

SCRs 8 AMPERES RMS 400 thru 800 VOLTS



TO-220AB
CASE 221A-09
STYLE 3

MARKING DIAGRAM



- A = Assembly Location
- Y = Year
- WW = Work Week
- x = D, M, or N
- G = Pb-Free Package
- AKA = Diode Polarity

PIN ASSIGNMENT

| Pin | Assignment |
|-----|------------|
| 1 | Cathode |
| 2 | Anode |
| 3 | Gate |
| 4 | Anode |

ORDERING INFORMATION

| Device | Package | Shipping |
|---------|-----------------------|-----------------|
| MCR8SDG | TO-220AB (Pb-Free) | 50 Units / Rail |
| MCR8SMG | TO-220AB (Pb-Free) | 50 Units / Rail |
| MCR8SNG | TO-220AB (Pb-Free) | 50 Units / Rail |

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Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------|---------------|
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 2.2 | $^{\circ}C/W$ |
| Junction-to-Ambient | $R_{\theta JA}$ | 62.5 | |
| Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds | T_L | 260 | $^{\circ}C$ |

Electrical Characteristics ($T_J = 25^{\circ}C$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------|--------|-----|-----|-----|------|
|----------------|--------|-----|-----|-----|------|

OFF CHARACTERISTICS

| | | | | | |
|--|------------------------|---|---|-----------|---|
| Peak Repetitive Forward or Reverse Blocking Current (Note 3) ($V_D = \text{Rated } V_{DRM} \text{ and } V_{RRM}; R_{GK} = 1 \text{ k}\Omega$) | I_{DRM} I_{RRM} | - | - | 10 500 | μA |
| | | | | | $T_J = 25^{\circ}C$ $T_J = 110^{\circ}C$ |

ON CHARACTERISTICS

| | | | | | |
|--|----------|-----|------|-----|----------------------|
| Peak Forward On-State Voltage (Note 2) ($I_{TM} = 16 \text{ A}$) | V_{TM} | - | - | 1.8 | V |
| Gate Trigger Current (Continuous dc) (Note 4) ($V_D = 12 \text{ V}; R_L = 100 \Omega$) | I_{GT} | 5.0 | 25 | 200 | μA |
| Holding Current (Note 3) ($V_D = 12 \text{ V}$, Gate Open, Initiating Current = 200 mA) | I_H | - | 0.5 | 6.0 | mA |
| Latch Current (Note 4) ($V_D = 12 \text{ V}, I_G = 200 \mu A$) | I_L | - | 0.6 | 8.0 | mA |
| Gate Trigger Voltage (Continuous dc) (Note 4) ($V_D = 12 \text{ V}; R_L = 100 \Omega$) | V_{GT} | 0.3 | 0.65 | 1.0 | V |
| | | - | - | 1.5 | |
| Gate Non-Trigger Voltage ($V_D = 12 \text{ V}, R_L = 100 \Omega$) | V_{GD} | 0.2 | - | - | V |
| | | | | | $T_J = 110^{\circ}C$ |

DYNAMIC CHARACTERISTICS

| | | | | | |
|--|---------|-----|----|-----|-----------|
| Critical Rate of Rise of Off-State Voltage ($V_D = 67\% V_{DRM}, R_{GK} = 1 \text{ k}\Omega, C_{GK} = 0.1 \mu F, T_J = 110^{\circ}C$) | dv/dt | 5.0 | 15 | - | $V/\mu s$ |
| Critical Rate of Rise of On-State Current $IPK = 50 \text{ A}, Pw = 40 \mu sec, diG/dt = 1 \text{ A}/\mu sec, Igt = 10 \text{ mA}$ | di/dt | - | - | 100 | $A/\mu s$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Indicates Pulse Test: Pulse Width $\leq 2.0 \text{ ms}$, Duty Cycle $\leq 2\%$.
3. $R_{GK} = 1000 \text{ Ohms}$ included in measurement.
4. Does not include R_{GK} in measurement.

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Voltage Current Characteristic of SCR

| Symbol | Parameter |
|-----------|---|
| V_{DRM} | Peak Repetitive Off State Forward Voltage |
| I_{DRM} | Peak Forward Blocking Current |
| V_{RRM} | Peak Repetitive Off State Reverse Voltage |
| I_{RRM} | Peak Reverse Blocking Current |
| V_{TM} | Peak On State Voltage |
| I_H | Holding Current |

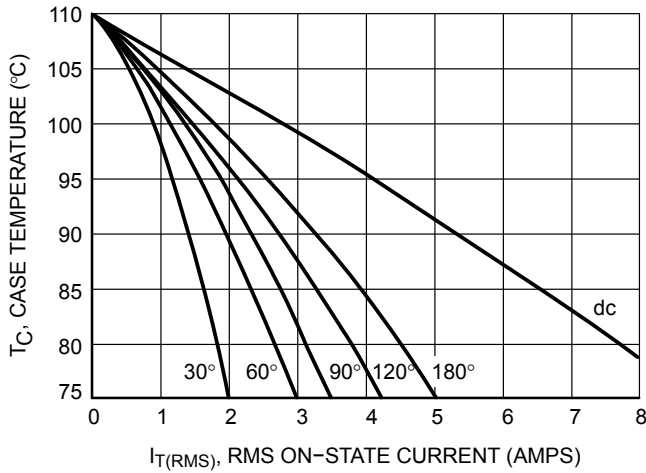
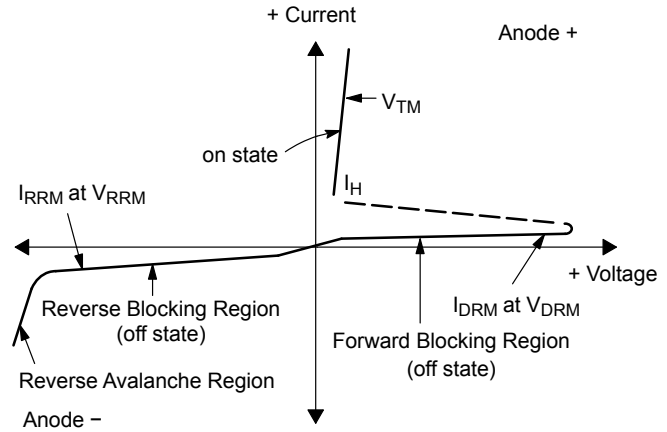


Figure 1. Typical RMS Current Derating

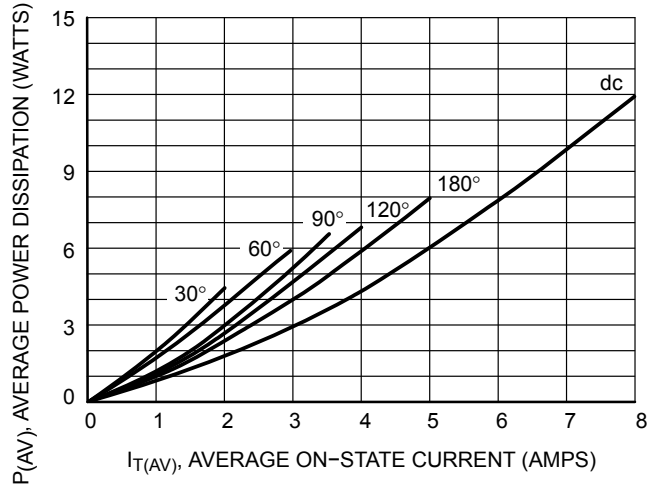


Figure 2. On-State Power Dissipation

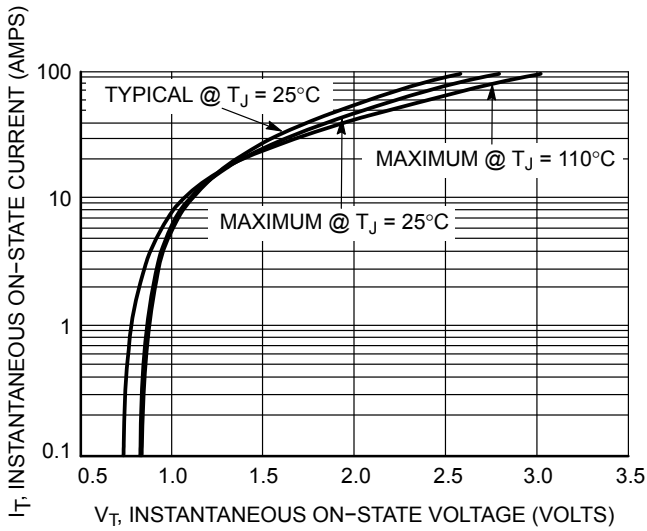


Figure 3. Typical On-State Characteristics

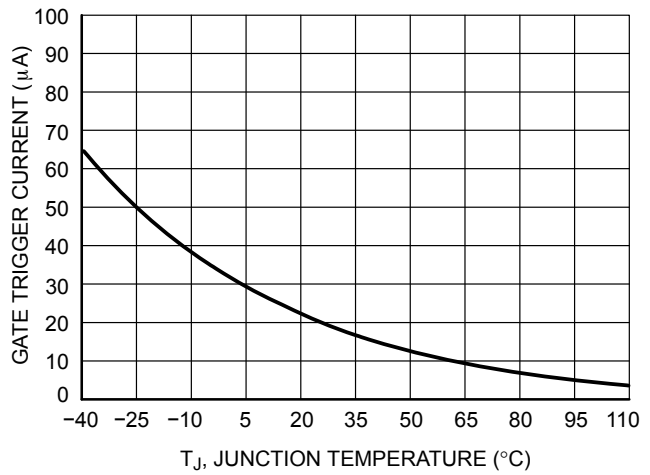


Figure 4. Typical Gate Trigger Current versus Junction Temperature

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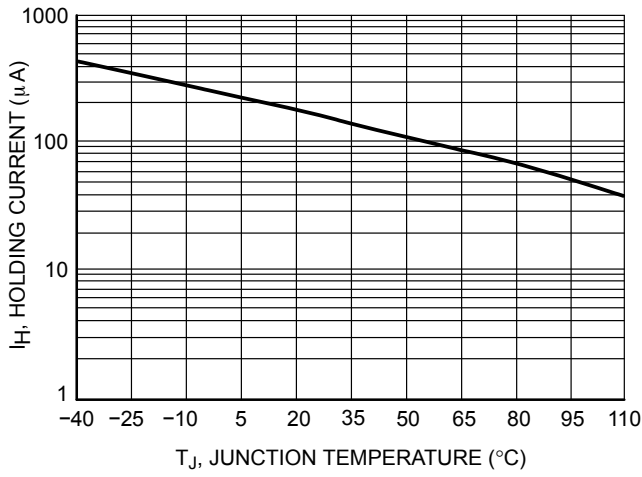


Figure 5. Typical Holding Current versus Junction Temperature

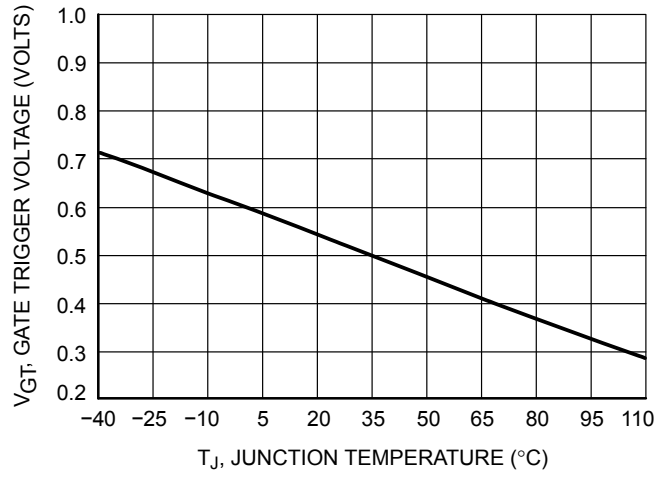


Figure 6. Typical Gate Trigger Voltage versus Junction Temperature

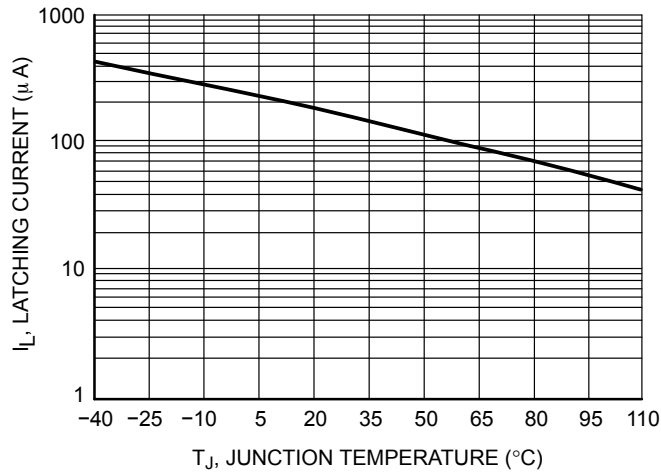
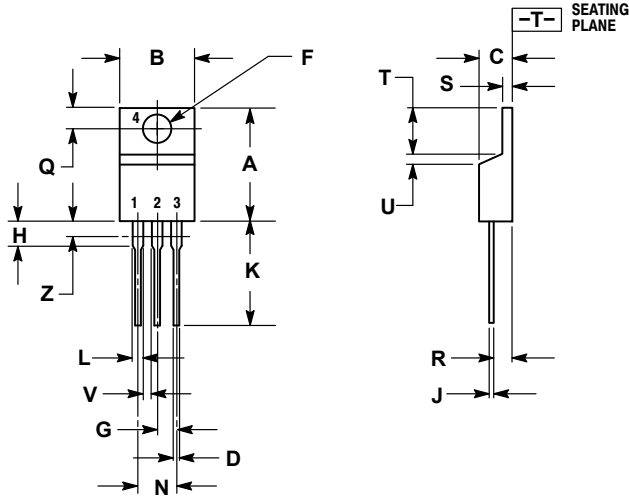


Figure 7. Typical Latching Current versus Junction Temperature

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PACKAGE DIMENSIONS

TO-220
CASE 221A-09
ISSUE AH



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

| DIM | INCHES | | MILLIMETERS | |
|-----|--------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.570 | 0.620 | 14.48 | 15.75 |
| B | 0.380 | 0.415 | 9.66 | 10.53 |
| C | 0.160 | 0.190 | 4.07 | 4.83 |
| D | 0.025 | 0.038 | 0.64 | 0.96 |
| F | 0.142 | 0.161 | 3.61 | 4.09 |
| G | 0.095 | 0.105 | 2.42 | 2.66 |
| H | 0.110 | 0.161 | 2.80 | 4.10 |
| J | 0.014 | 0.024 | 0.36 | 0.61 |
| K | 0.500 | 0.562 | 12.70 | 14.27 |
| L | 0.045 | 0.060 | 1.15 | 1.52 |
| N | 0.190 | 0.210 | 4.83 | 5.33 |
| Q | 0.100 | 0.120 | 2.54 | 3.04 |
| R | 0.080 | 0.110 | 2.04 | 2.79 |
| S | 0.045 | 0.055 | 1.15 | 1.39 |
| T | 0.235 | 0.255 | 5.97 | 6.47 |
| U | 0.000 | 0.050 | 0.00 | 1.27 |
| V | 0.045 | --- | 1.15 | --- |
| Z | --- | 0.080 | --- | 2.04 |

STYLE 3:

- PIN 1. CATHODE
2. ANODE
3. GATE
4. ANODE

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